

Title (en)
ADHESIVE COMPOSITIONS.

Title (de)
KLEBMITTELZUSAMMENSETZUNG.

Title (fr)
COMPOSITIONS ADHESIVES.

Publication
EP 0093778 A4 19840406 (EN)

Application
EP 83900213 A 19821109

Priority
• US 31921181 A 19811109
• US 31970081 A 19811109

Abstract (en)
[origin: WO8301623A1] Hot melt adhesive compositions which include a hydrogenated block copolymer such as Kraton G, about 25 to about 250 parts by weight of a hydrocarbon resin made from a petroleum or coal tar distillate, aliphatic dienes and mono and diolefins, cyclic olefins of 5 to 6 carbon atoms and hydrogenated polycyclics per 100 parts by weight of the hydrogenated block copolymer, and about 25 to about 200 parts by weight of a polybutene or polyisobutylene per 100 parts of the hydrogenated block copolymer. Pressure sensitive adhesive compositions may be prepared by dissolving such mixture of ingredients in a non-reactive solvent at a concentration level of about 5 to about 25 grams 100 ml of non-reactive solvent.

IPC 1-7
C08G 18/00

IPC 8 full level
C08L 23/00 (2006.01); **C08L 23/20** (2006.01); **C08L 23/18** (2006.01); **C08L 53/00** (2006.01); **C08L 53/02** (2006.01); **C08L 57/02** (2006.01); **C08L 101/00** (2006.01); **C09J 121/00** (2006.01); **C09J 123/18** (2006.01); **C09J 123/20** (2006.01); **C09J 123/22** (2006.01); **C09J 153/00** (2006.01); **C09J 153/02** (2006.01); **C09J 157/00** (2006.01)

CPC (source: EP)
C09J 123/20 (2013.01); **C09J 123/22** (2013.01); **C09J 153/025** (2013.01); **C08L 2666/02** (2013.01); **C08L 2666/28** (2013.01)

C-Set (source: EP)
1. **C09J 123/20 + C08L 2666/02**
2. **C09J 123/22 + C08L 2666/02**
3. **C09J 153/025 + C08L 2666/02 + C08L 2666/28**
4. **C09J 153/025 + C08L 2666/02**

Citation (search report)
• US 4138378 A 19790206 - DOSS RICHARD C
• US 3837994 A 19740924 - FLANAGAN T, et al

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WO 8301623 A1 19830511; EP 0093778 A1 19831116; EP 0093778 A4 19840406; IT 1189416 B 19880204; IT 8249456 A0 19821109; JP S58501863 A 19831104

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US 8201585 W 19821109; EP 83900213 A 19821109; IT 4945682 A 19821109; JP 50025783 A 19821109